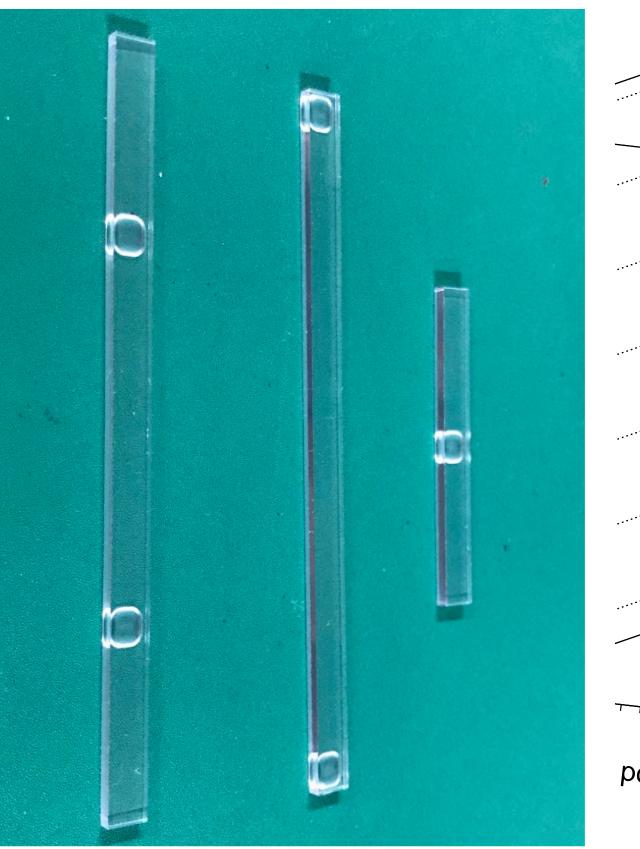
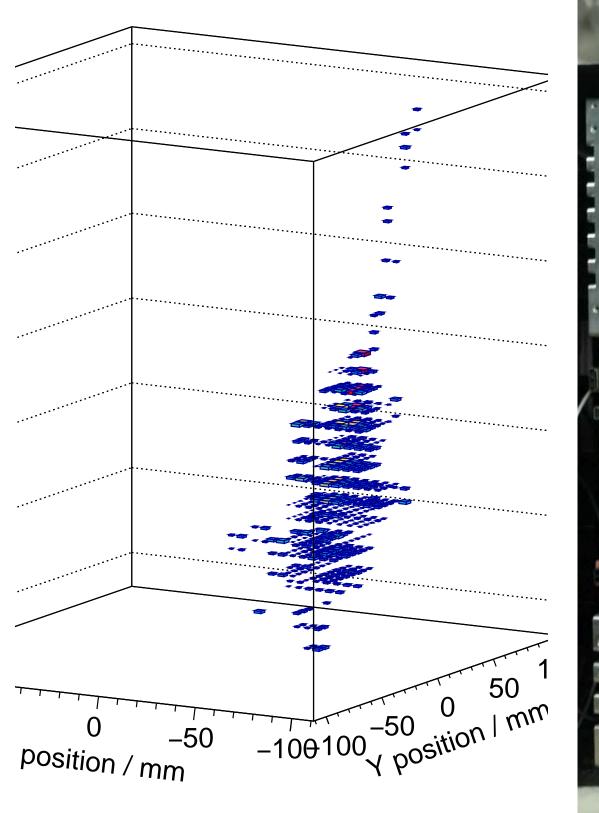
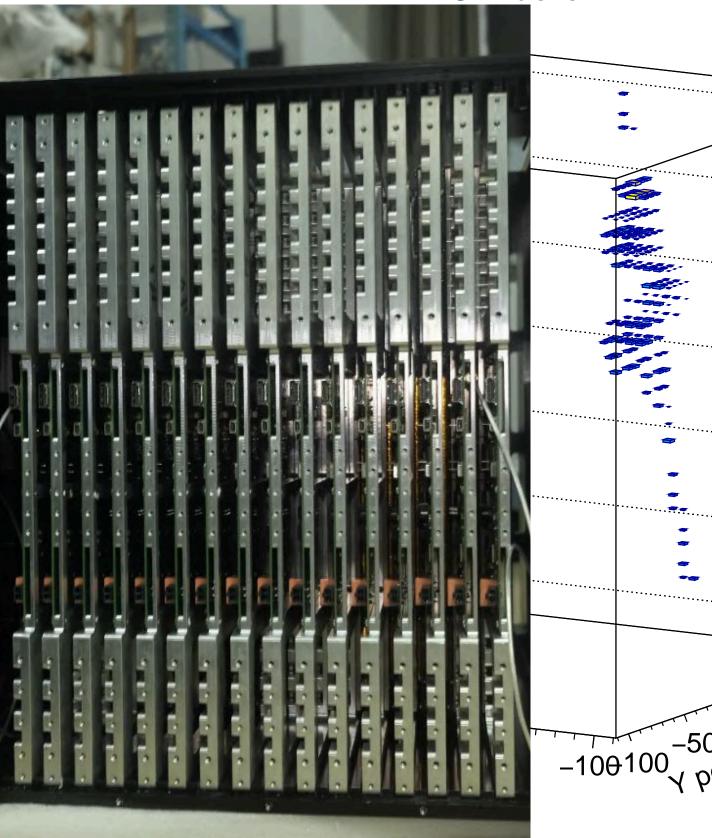
Sc-ECAL Status and Perspectives

W. Ootani ICEPP, Univ. of Tokyo on behalf of Sc-ECAL group

ILC TC meeting, Mar. 24th, 2022 CR data





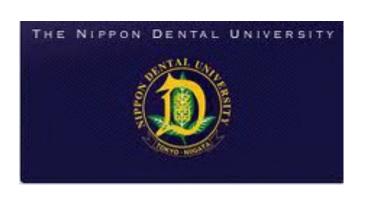


Sc-ECAL Group

ILD R&D group





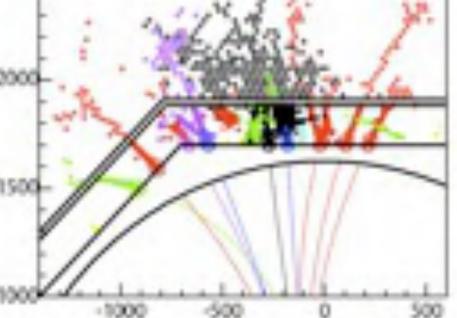




CEPC R&D group







Sc-ECAL in a Nutshell

ECAL

m×5mm×t2mm) readout by SiPM

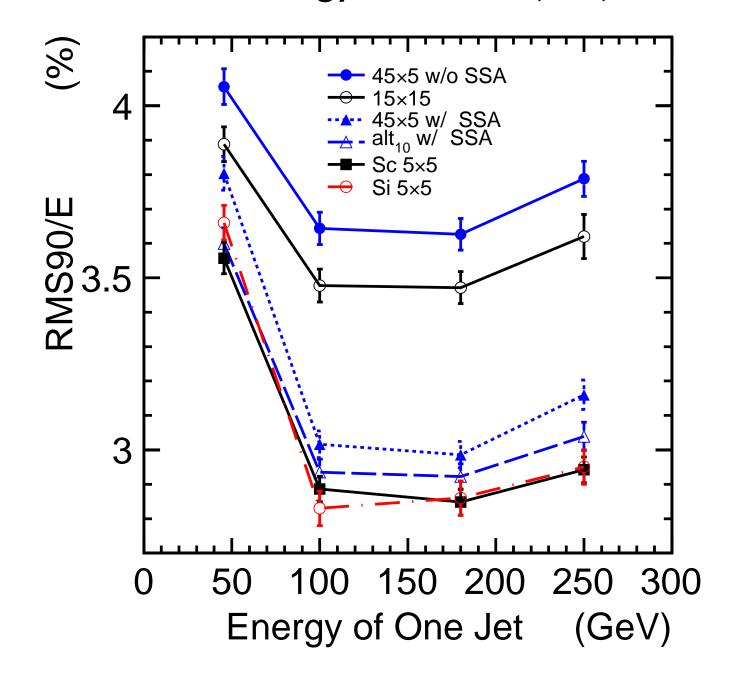
• vii tuai segimentation of 5×5mm² by strips aligned alternately in horizontal and vertical orientations

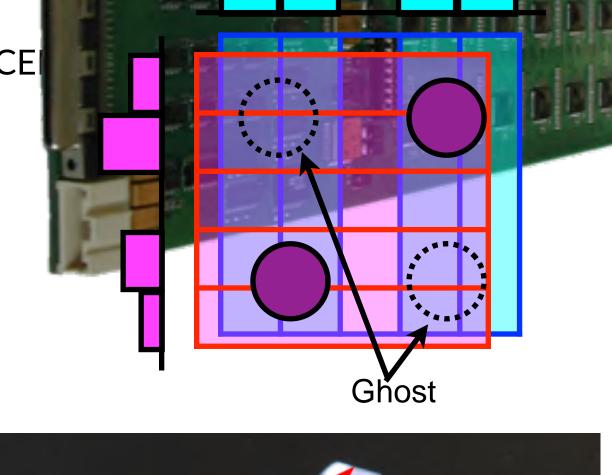
• Significant reduction of readout channels($10^8 \rightarrow 10^7$) retaining performance

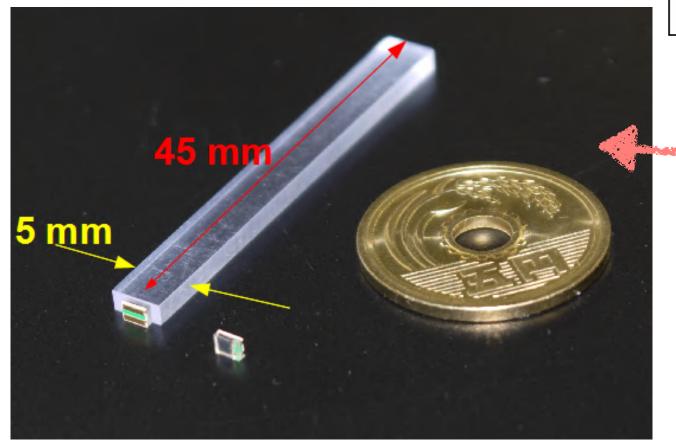
Cost reduction

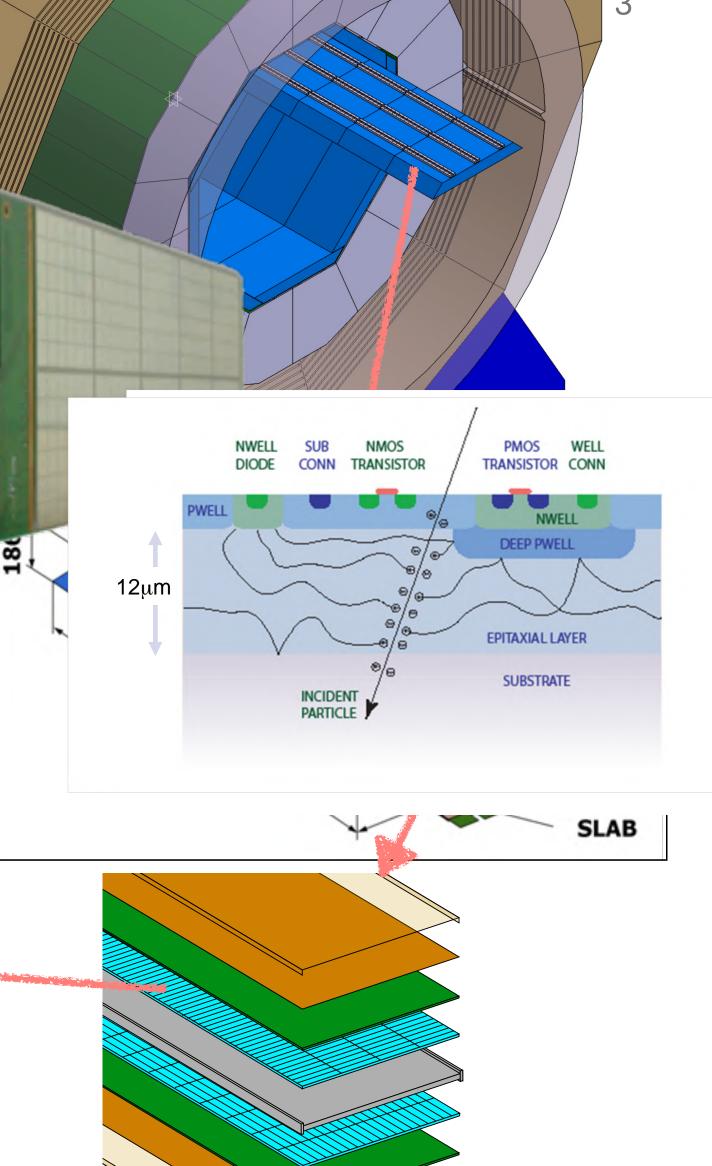
Power consumption reduction → advantageous especially for CEI

Jet energy resolution (MC)







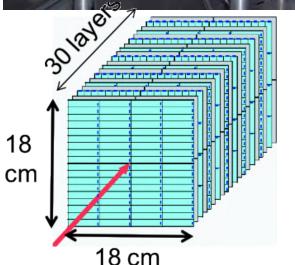


Brief History

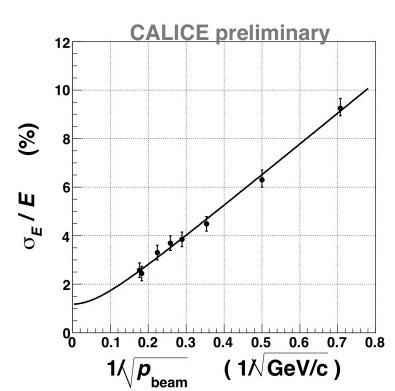
We are here

Physics prototype

- Scintillator ($45 \times 10 \times 3 \text{ mm}^3$) readout by WLS fibre+SiPM
- Demonstrated good performance (energy resolution and linearity) using 2-32GeV electron at Fermilab



2-32GeV electron @ Fermilab

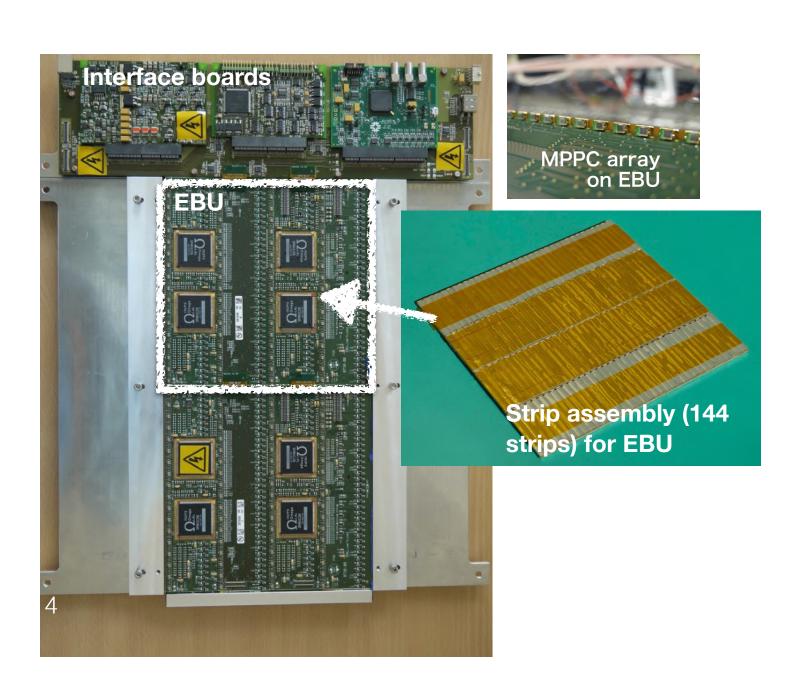


 $= \frac{(12.9 \pm 0.1 \pm 0.4)}{\sqrt{E}} \oplus (1.2 \pm 0.1^{+0.4}_{-1.2})\%$

Non-linearity < ±2%

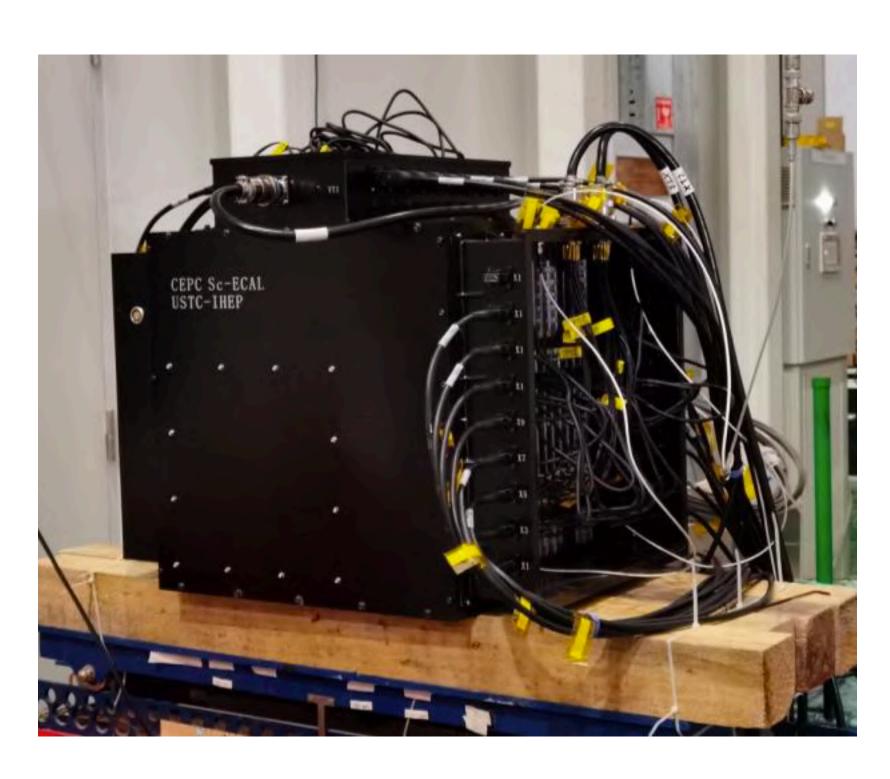
Technological prototype: single layer

- Scintillator strip ($45 \times 5 \times 2 \text{ mm}^3$) directly coupled to SiPM
- Strips are assembled on PCB with integrated readout electronics ("EBU")
- 144 strips/EBU readout by 4 ASICs (SPIROC2b)



Technological prototype: full layer

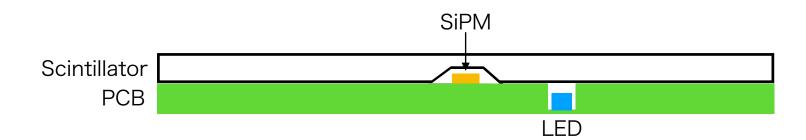
- Joint R&D with CEPC-ECAL group
- Scintillator strip ($45 \times 5 \times 2 \text{ mm}^3$) with SiPM
- 32 layers, $\sim 23.4 X_0$
- 210ch /EBU



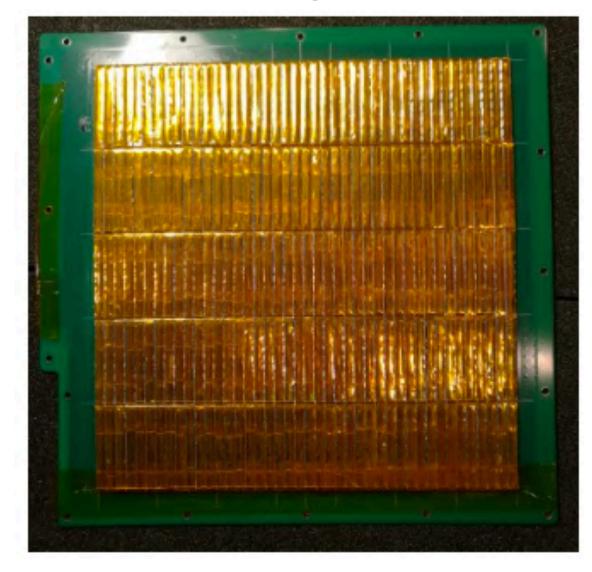
Large technological prototype of Sc-ECAL

- Jointly developed by R&D groups for CEPC and ILD
- Full layers (32 layers)
 - Detection layer of 210×225mm² with 210 scintillator-strips
 - 30 layers with single SiPM readout
 - 2 layers with double SiPM readout
 - Absorber plate (3.2mm-thick 15%-85% Cu-W alloy)
 - Total material thickness $23.4 X_0$

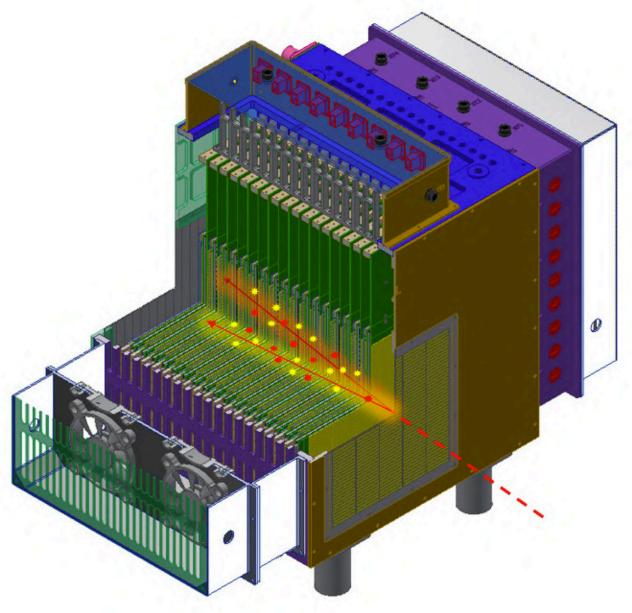
Strip-SiPM coupling



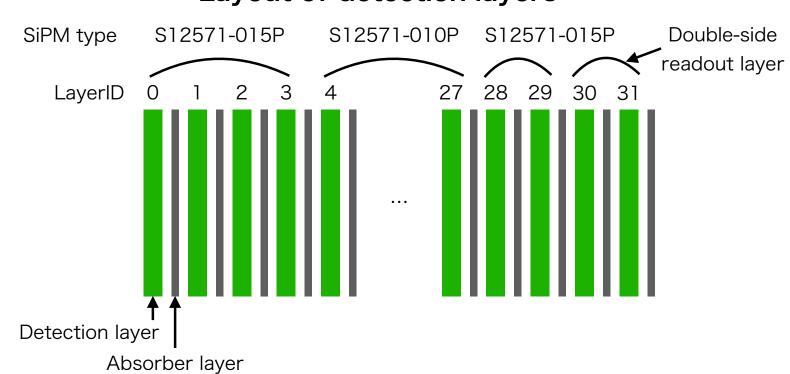
Detection layer on EBU



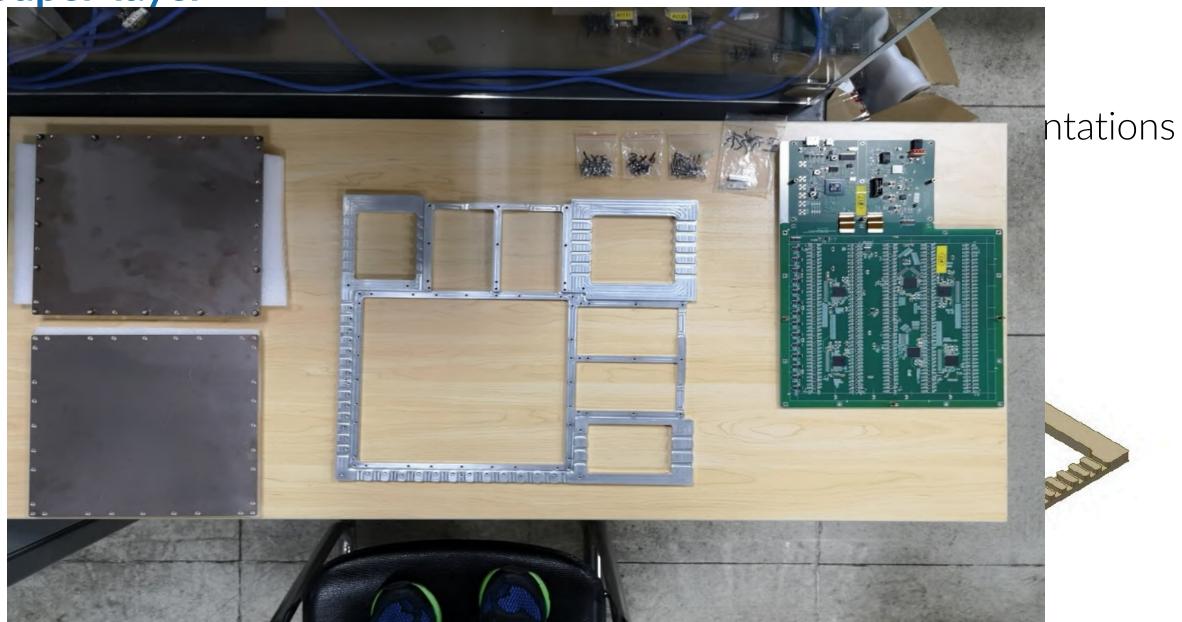
Large prototype

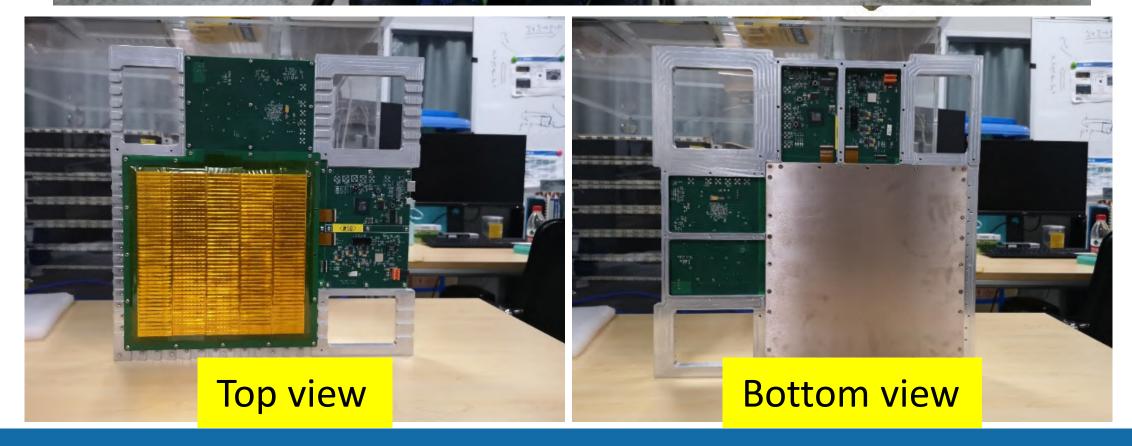


Layout of detection layers



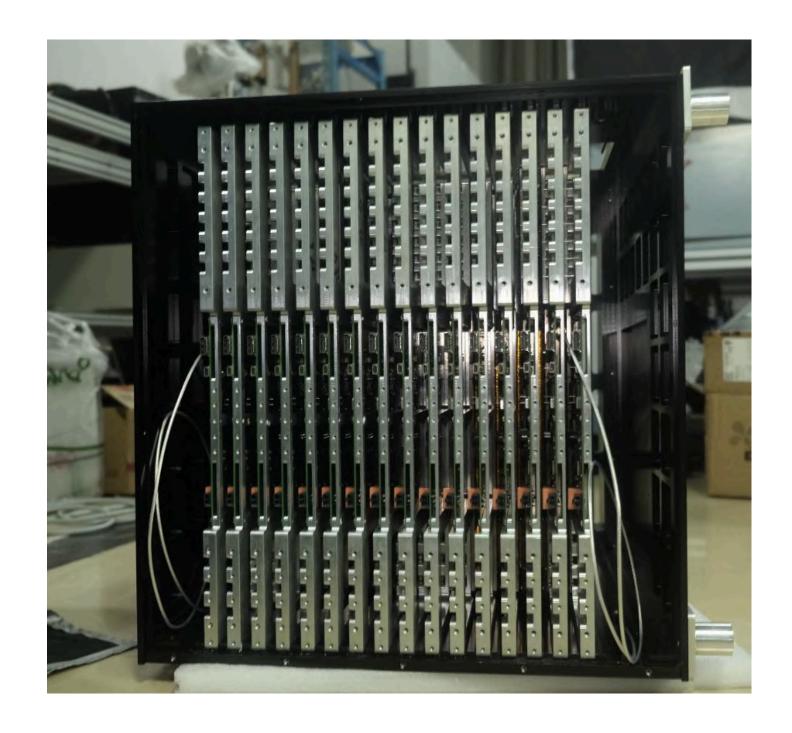
Super-layer



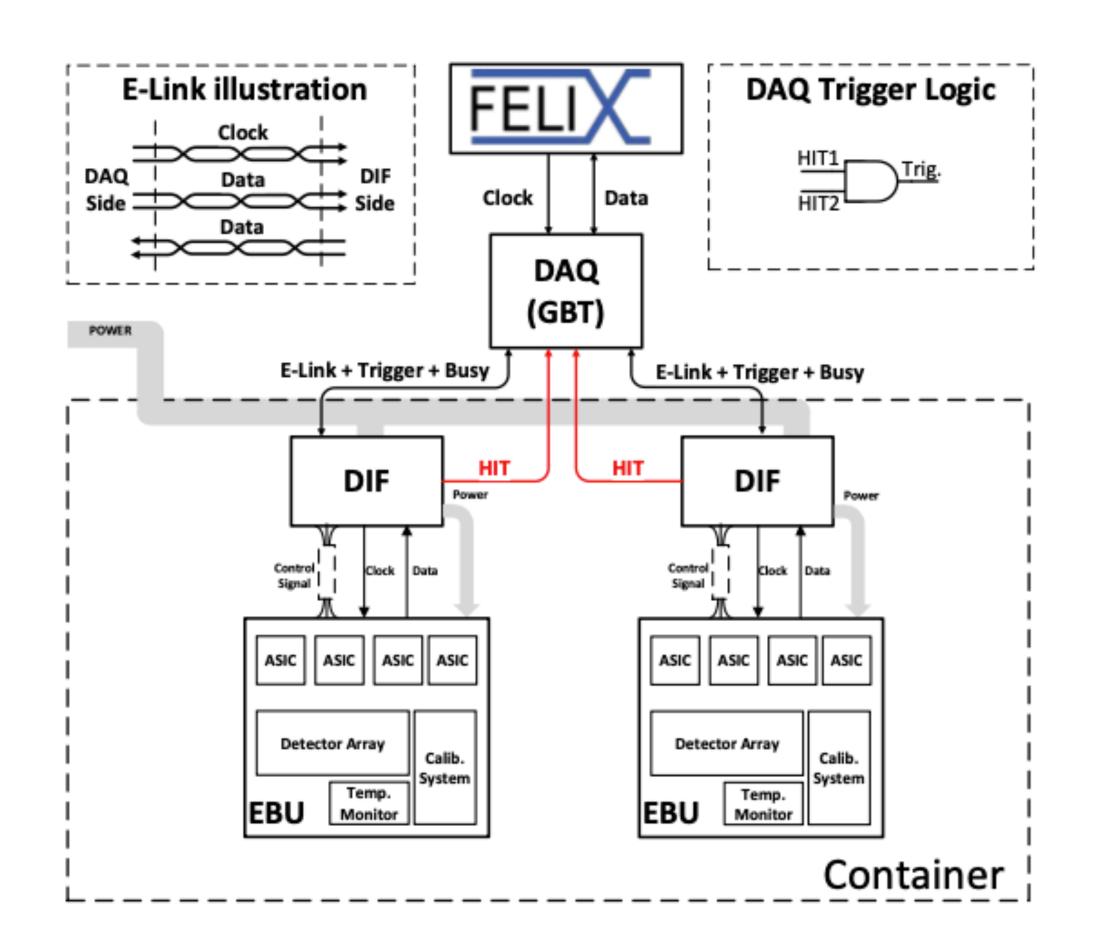


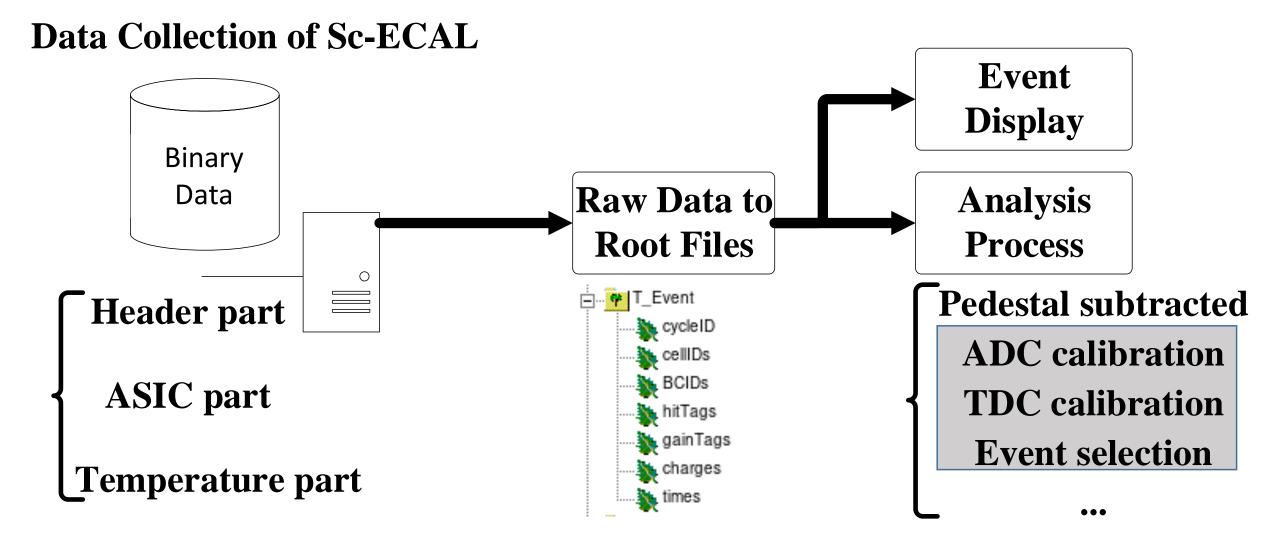
Mechanical structure

- \bullet Mechanical structure with $17 \times$ slots for super-layer modules
- ullet Whole setup can be rotated by 90° for cosmic ray test
- Air-cooling fans at both sides



Large Prototype DAQ

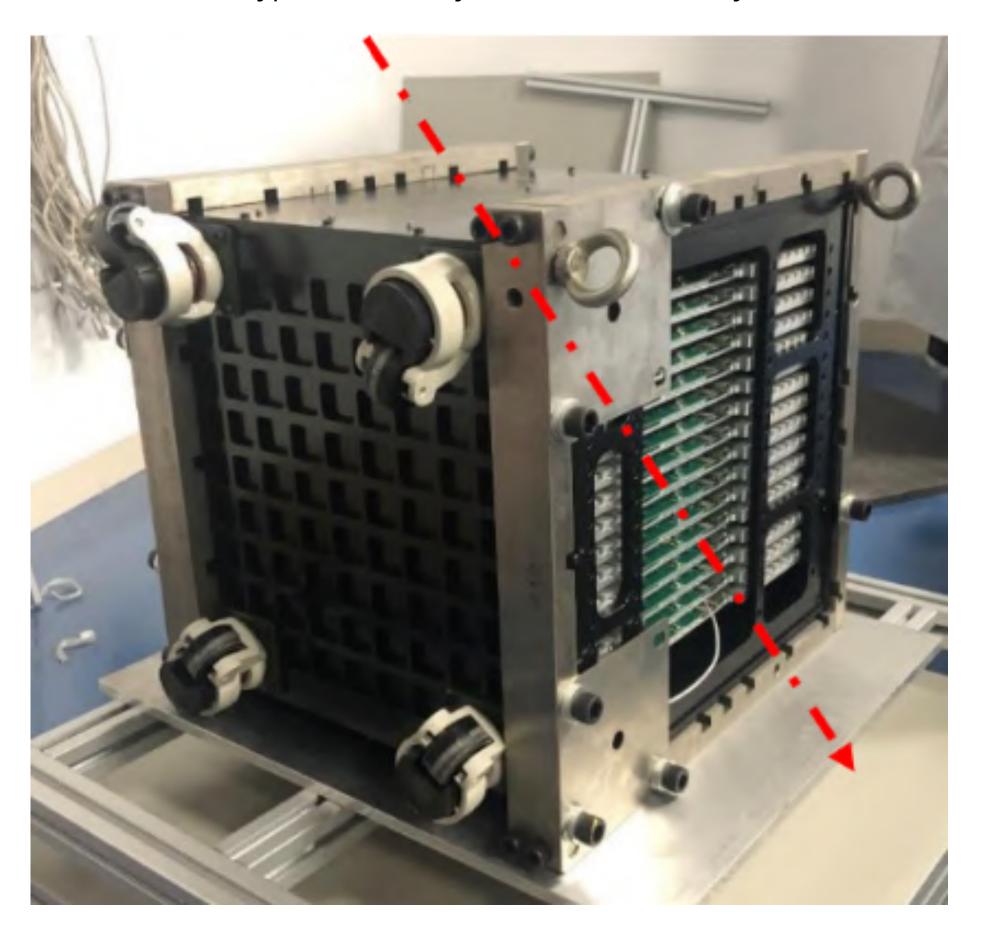




Commissioning

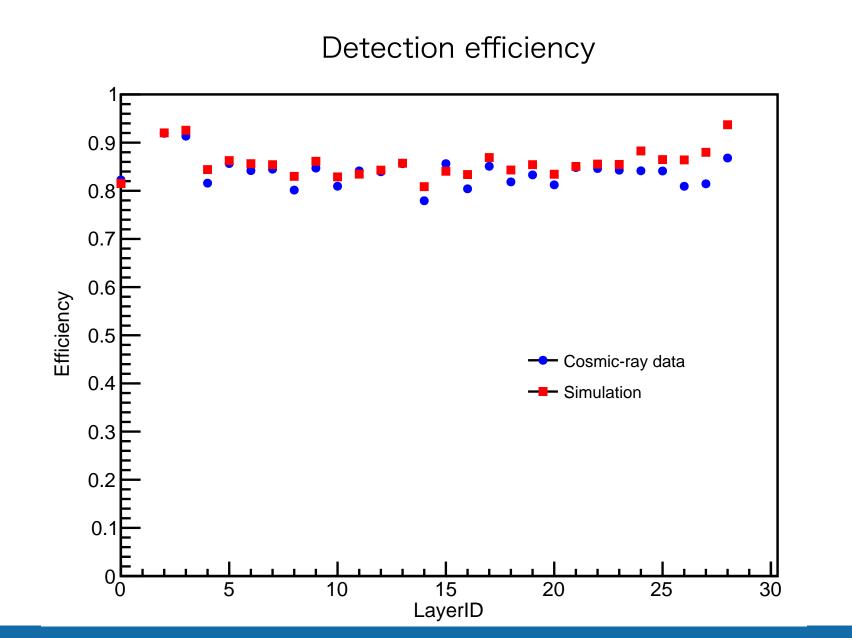
- No beam test performed yet due to pandemic
- Long LED run (~1 month)
 - SiPM calibration (gain, cross-talk, after-pulsing)
 - Electronics calibration
 - Stability test
- Long cosmic ray run (~3 month)
 - MIP calibration
 - Stability test
 - Performance study
 - Detection efficiency, position resolution
 - Study with cosmic-ray induced shower

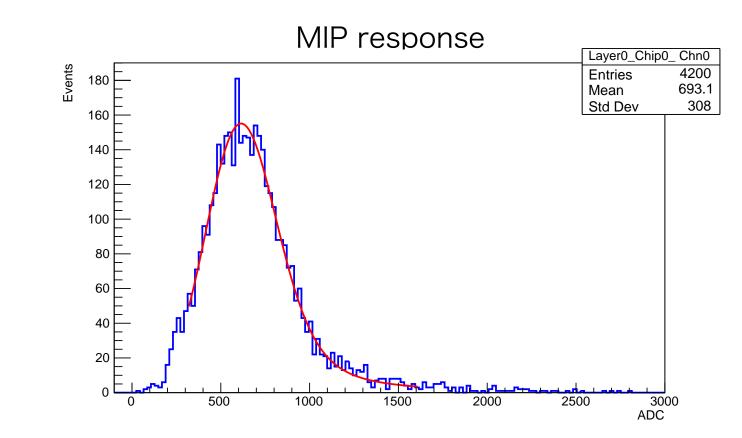
Prototype rotated by 90° for cosmic-ray test

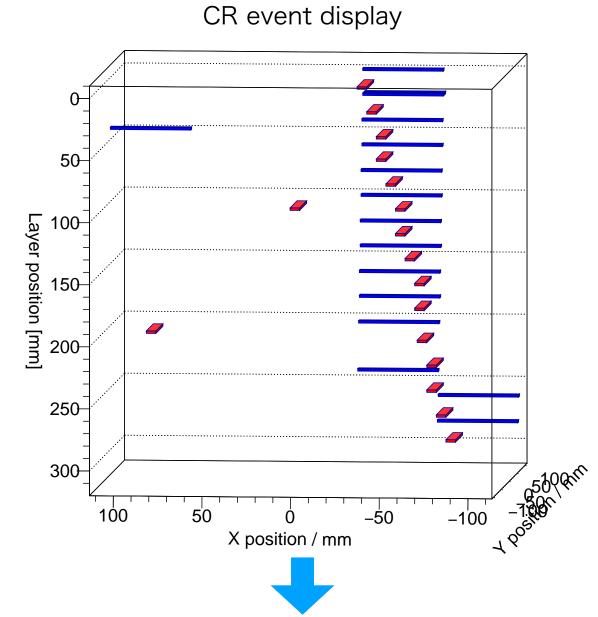


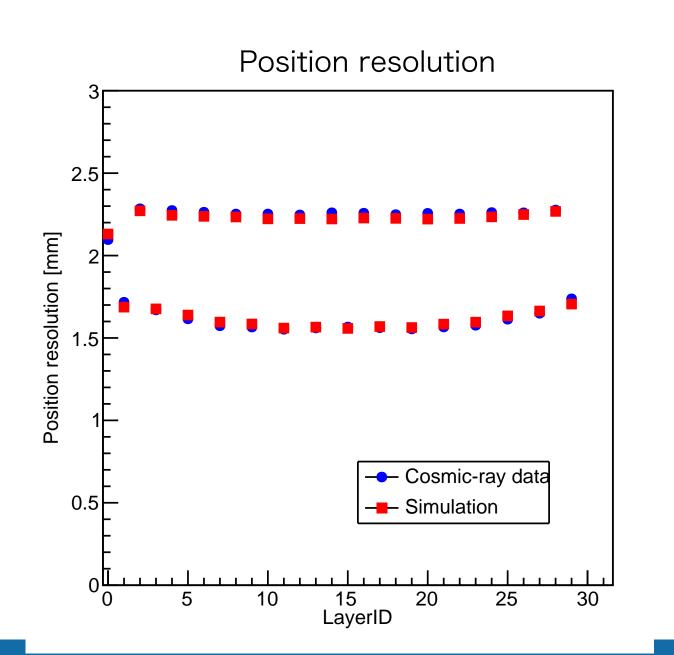
Performance

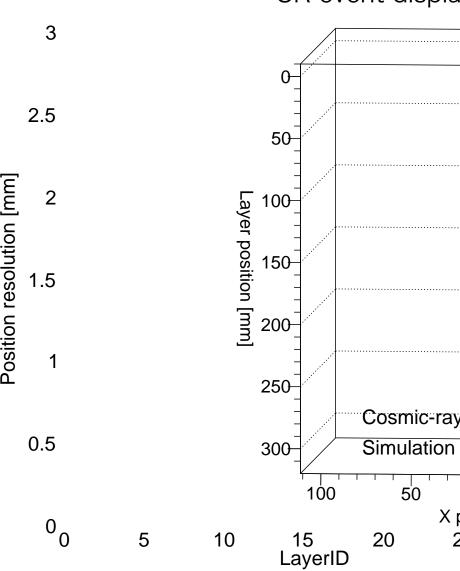
- Performance measurement with cosmic ray track
- Detection efficiency
 - •80-90%
 - Inefficiency due to threshold and gap between strips
- Position resolution
 - •1.5-2.3mm

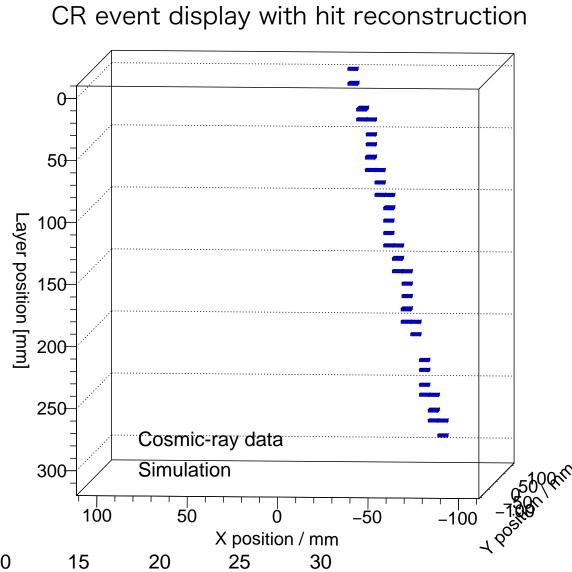








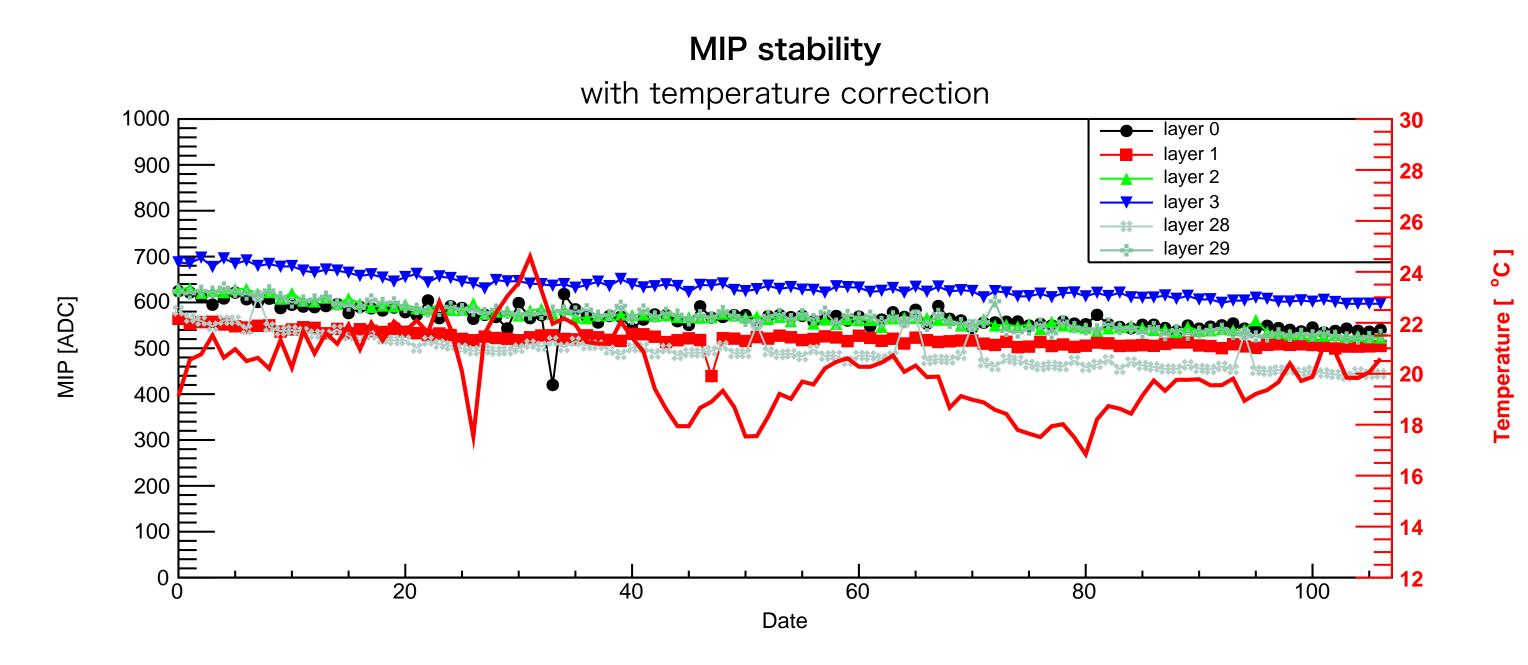


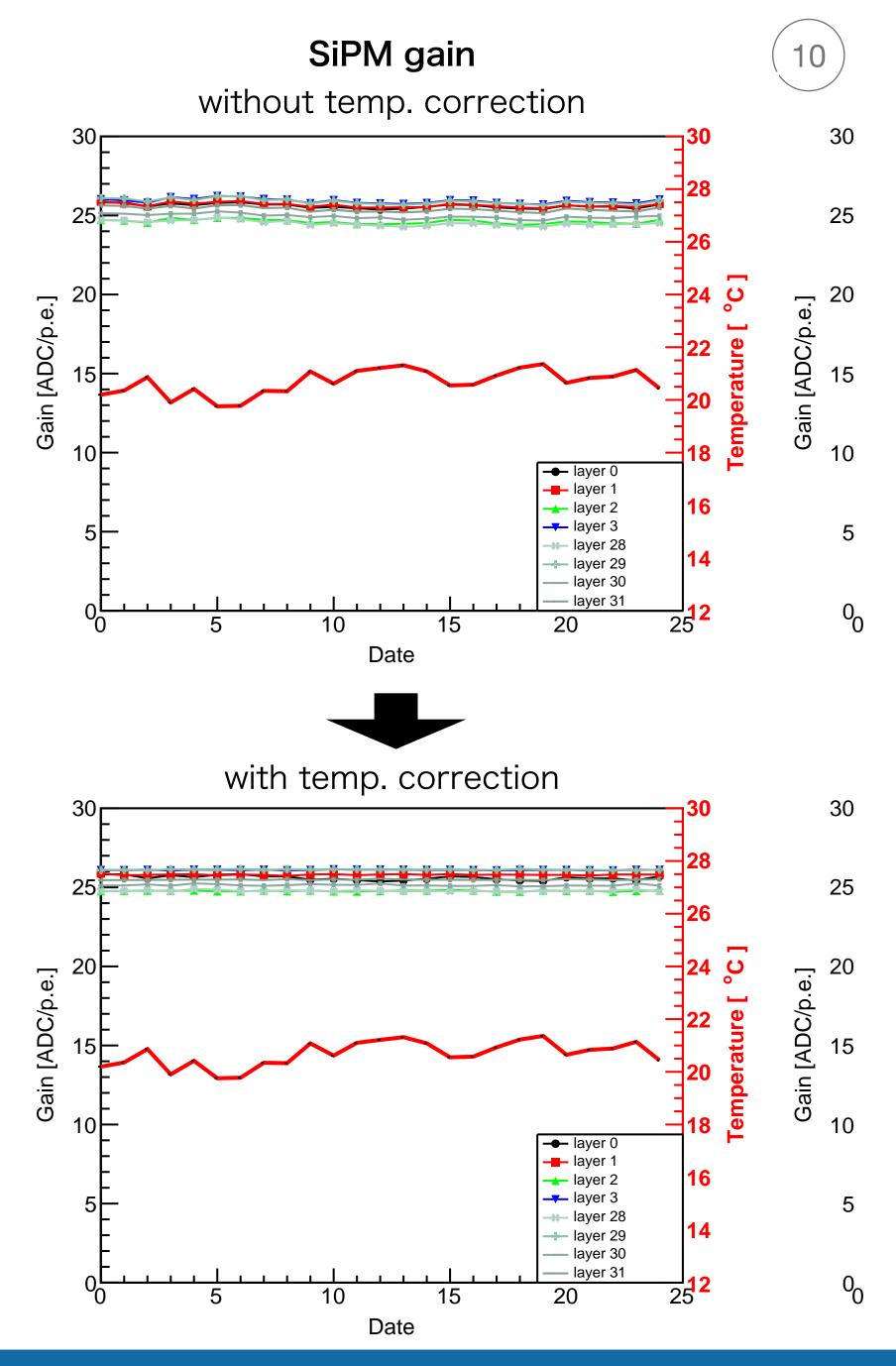


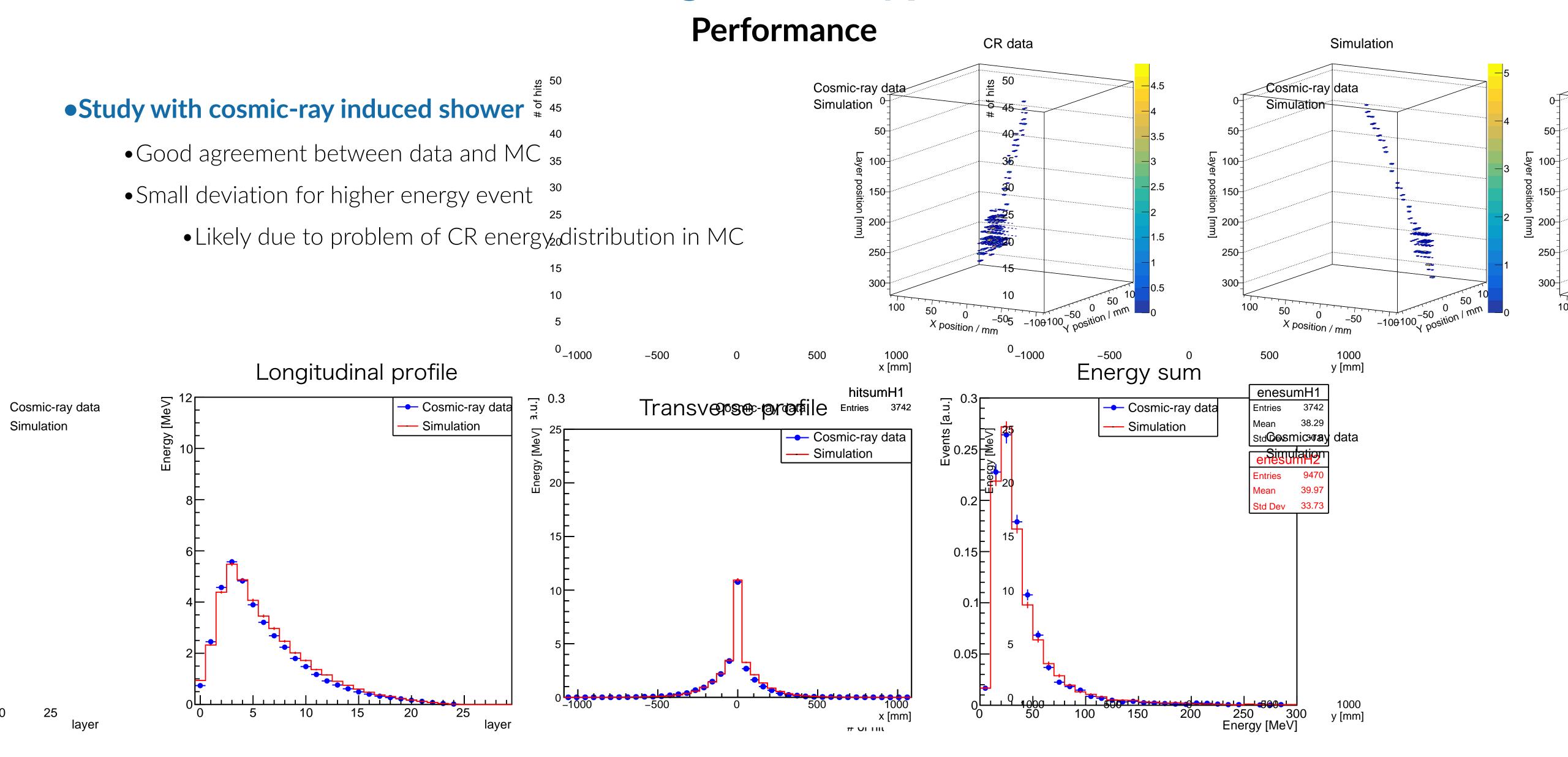
Performance

Long-term stability

- •SiPM gain
 - Very stable over one month
- MIP gain
 - Constant decrease of 5-10%/3months
 - ↔ 1-2%/year @T2K ND280/INGRID
 - Under investigation. Electronics or scintillator?







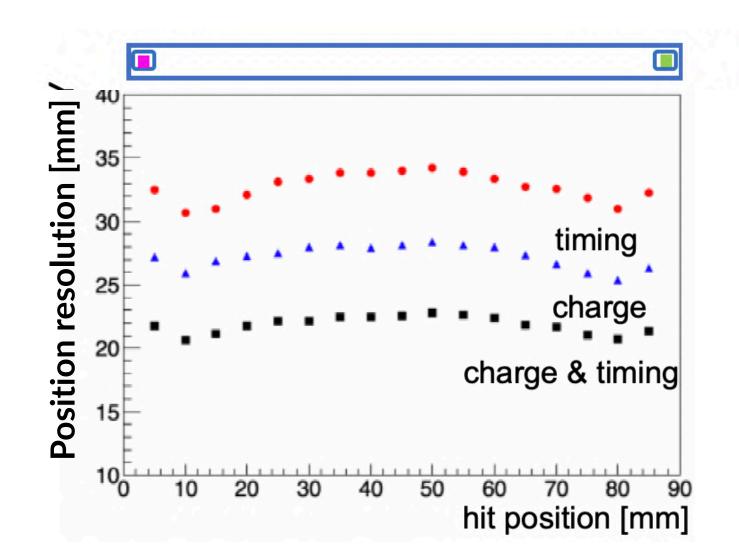
Timing

Timing capability recognised as additional value by Sc-E²

- Particle ID for charged hadron to cover inaccessible momenture.
 Rejection of File of Particle ID for charged hadron to cover inaccessible momentum.
 Rejection of File of Particle ID for charged hadron to cover inaccessible momentum.
- Rejection of slow neutron events
- Improve PFA performance

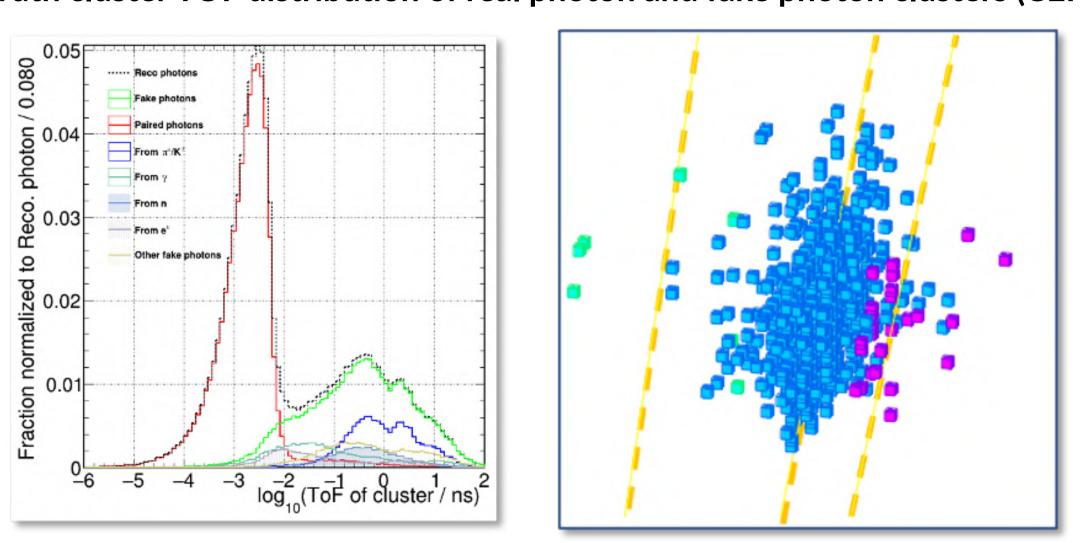
 $K^{\pm}/\pi^{\pm}/p^{\pm}$ Hit position reconstruction in double SiPM readout

Hit position resolution with double SiPM readout

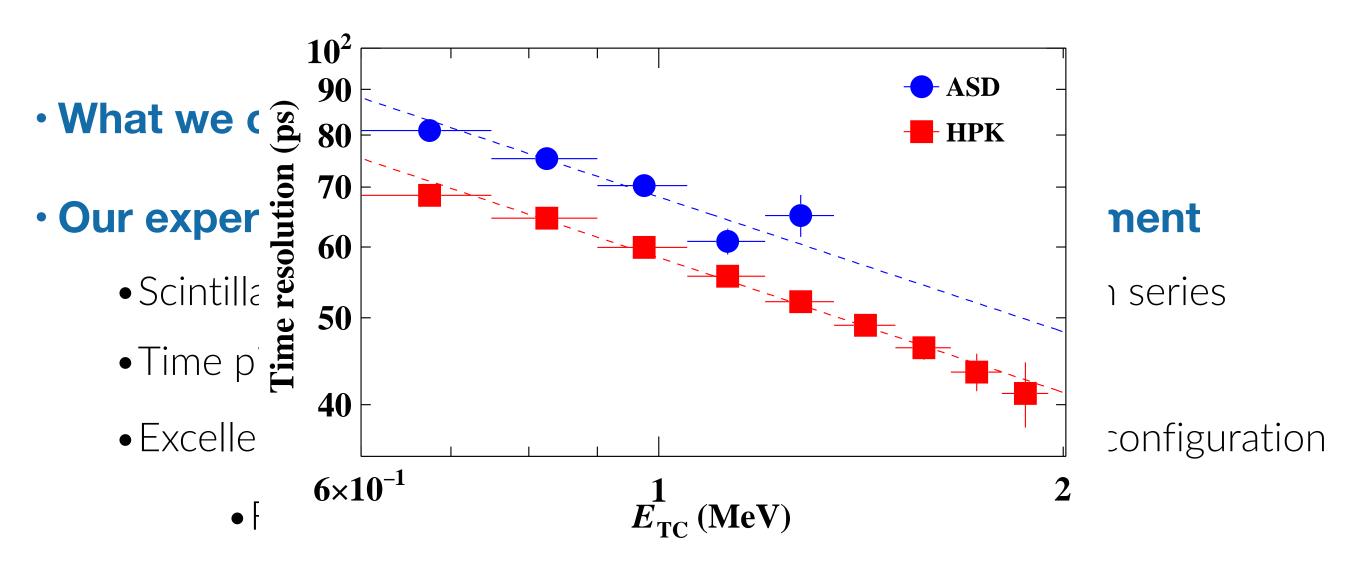


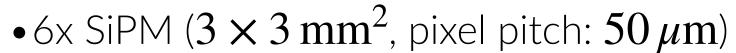
π/K , dEdx π/K , TOF50 $K/\pi dE/dx$ K/p dE/dx · K/π TOF K/p TOF K/π dE/dx+TOF K/p dE/dx+TOF 10² 10 p (GeV/c) p (GeV/c)

Truth cluster TOF distribution of real photon and fake photon clusters (CEPC)



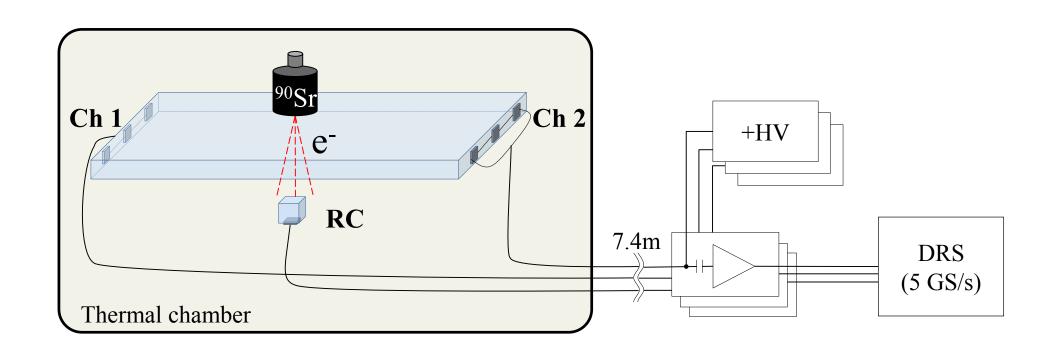
Timing

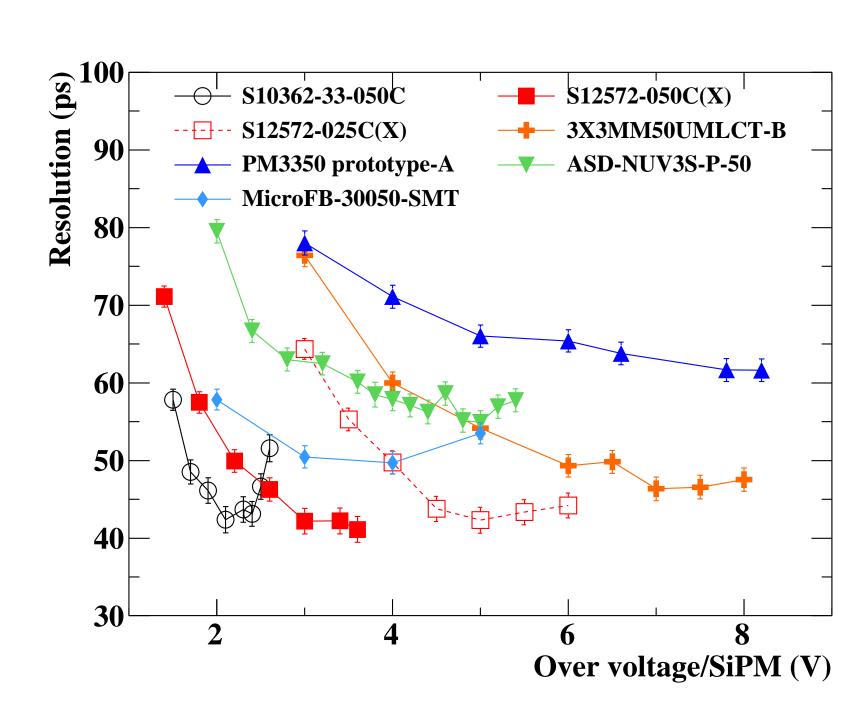




 \bullet Expected $70-80\,\mathrm{ps}$ with ~100 photoelectrons

Properties	BC-418	BC-420	BC-422	BC-422Q	BC-404
Light Output ^{a)} (% Anthracene)	67	64	55	19	68
Rise Time ^{a) b)} (ns)	0.5	0.5	0.35	0.11	0.7
Decay Time ^{a)} (ns)	1.4	1.5	1.6	0.7	1.8
Peak Wavelength ^{a)} (nm)	391	391	370	370	408
Attenuation Length ^{a)} (cm)	100	110	8	8	140
Time Resolution ^{c)} (ps)	48 ± 2	51 ± 2	43 ± 2	66 ± 3	_





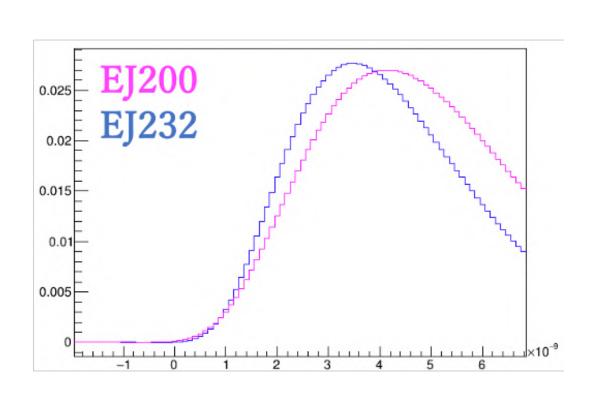
Timing

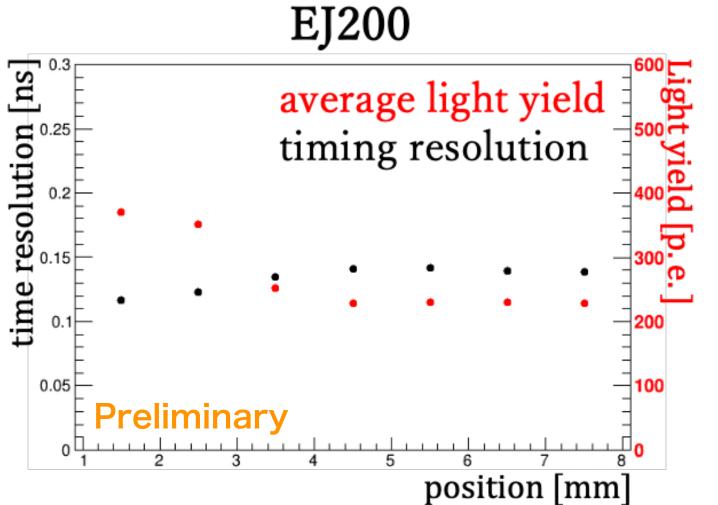
Dedicated study in progress

- Time resolution with standard strip-SiPM configuration: $300 400 \, \mathrm{ps}$
- Dedicated timing layer with scintillator tile + larger SiPM under consideration
 - Target resolution $\sim 50 \, \mathrm{ps}$
 - Tile layer would also help solving ghost hit in strip layers

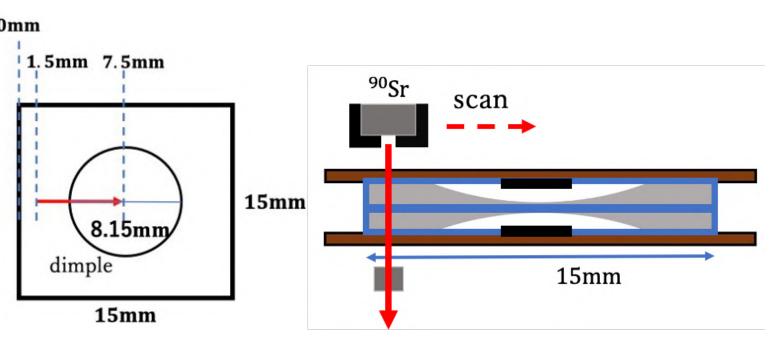
Preliminary results

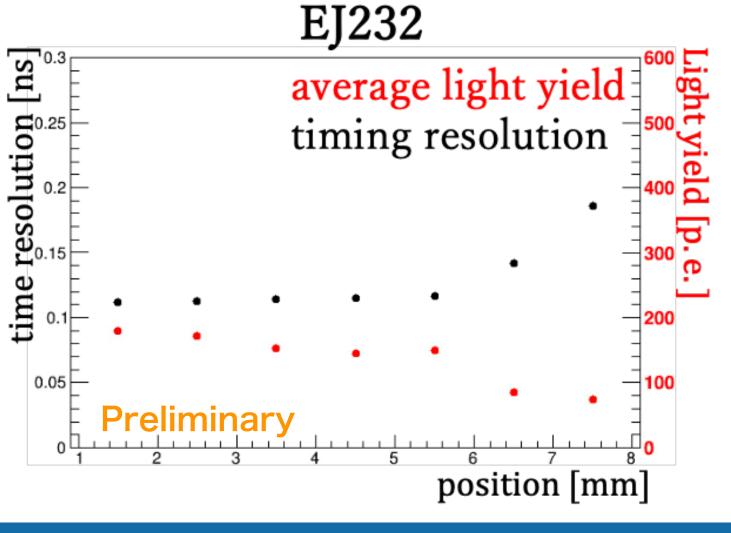
- Scintillator tile
 - $\bullet 15 \times 15 \times 3 \text{ mm}^3$
 - standard (EJ200 (=BC408)), fast (EJ232 (=BC422))
- •SiPM: MPPC S14160-3050HS ($3 \times 3 \text{ mm}^2$, pixel pitch: $50 \, \mu\text{m}$)...
- Resolution down to $\sim 110 \, \mathrm{ps}$
 - Worse than that for MEG II detector even with higher p.e. statistics
 - Difference is not understood yet







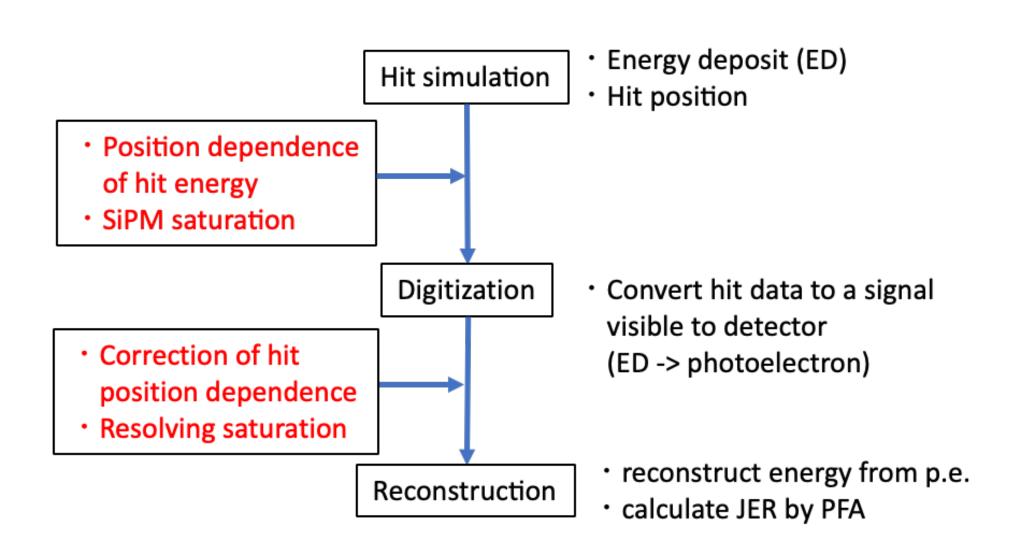




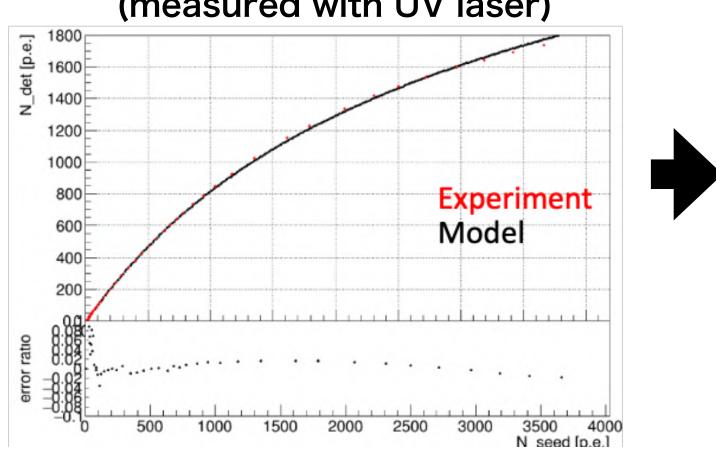
More Realism in Simulation

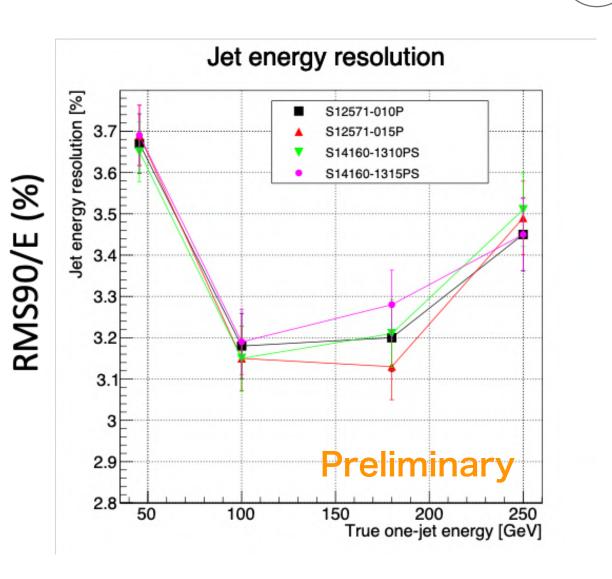
Realistic conditions to implement in simulation

- ✓ •SiPM saturation
- ✓ Hit position dependence of light yield
- ✓ Misalignment between strip and SiPM
 - Gap between strips (deal area)
 - ...

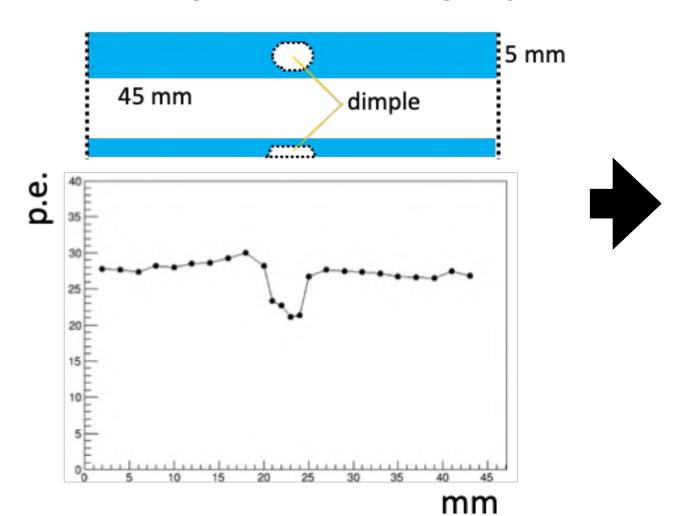


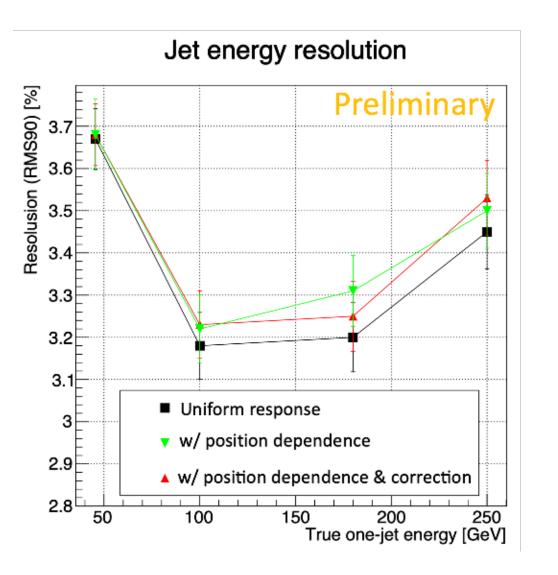
SiPM saturation (measured with UV laser)





Position dependence of light yield





Remaining Challenges

Performance evaluation in beam test

- Standalone beam test at IHEP BSRF (leakage electron from synchrotron radiation by
- Combined beam test at CERN with Sc-ECAL and CEPC-AHCAL

Engineering R&D for large scale production

- Scintillator production (injection moulding)
- Automated assembly system
- System for QC/QA
- →More reliable cost estimate

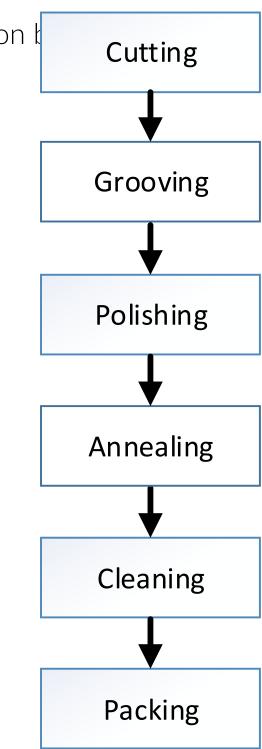
Readout electronics

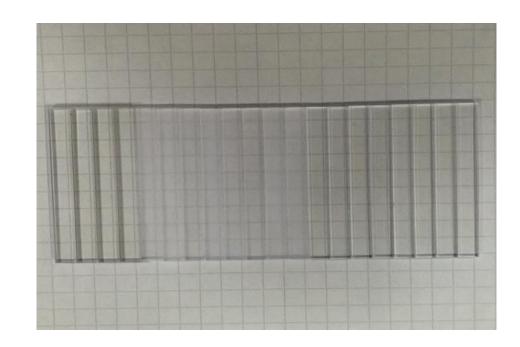
- Power pulsing operation
- Long slab
- Electronics dedicated for timing

Design of infrastructure in ILD

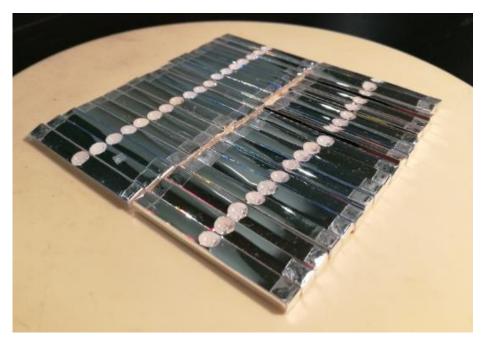
Most urgent R&D items from CEPC viewpoint

- Low-power and high-performance SiPM readout ASIC
- Active cooling











Strip wrapping and assembly on EBU was done by hand (Shanghai Institute of Ceramic)

· No substantial activity has been started for any other items than preparation for the beam tests

- No sufficient manpower and funding for both Chinese and Japanese sides
- Newcomers would be welcome in these area